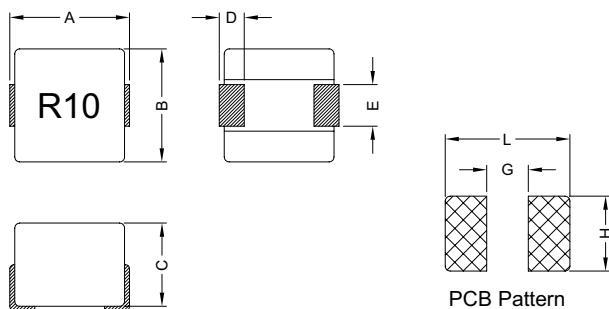


1. PART NO. EXPRESSION :

SSL0605 - R10YF
 (a) (b) (c) (d)(e)

- (a) Series code
- (b) Dimension code
- (c) Inductance code : R10 = 0.10uH
- (d) Tolerance code : Y = ±30%
- (e) F : Lead Free

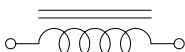
2. CONFIGURATION & DIMENSIONS :



Unit:m/m

A	B	C	D	E	G	H	L
7.2 Max.	6.8 Max.	5.0 Max.	1.5±0.5	2.5±0.5	2.5 Max.	4.5 Max.	7.5 Max.

3. SCHEMATIC :



4. GENERAL SPECIFICATION :

- a) Operating temp. : -55°C to +125°C
- b) Storage temp. : -55°C to +125°C
- c) Irms (A) : Will cause coil temp. to rise approximately ΔT=40°C without core loss.
- d) Isat (A) : Will cause L₀ to drop approximately 20%
- e) Part temperature (ambient + temp. rise) : Should not exceed 125°C under worst case operating conditions.

5. ELECTRICAL CHARACTERISTICS :

Part No.	Inductance L ₀ (uH)	Test Freq. (Hz)	DCR (mΩ) Max.	Irms (A) Max.	Isat (A) Max.
SSL0605-R10YF	0.10 ±30%	0.25V/1M	0.50	30	37
SSL0605-R15YF	0.15 ±30%	0.25V/1M	0.50	24	30
SSL0605-R20YF	0.20 ±30%	0.25V/1M	0.50	19	24



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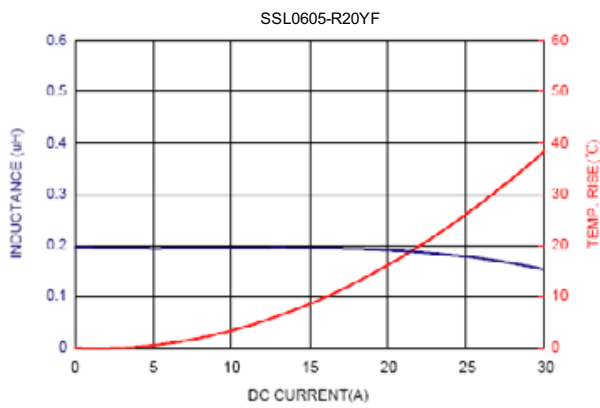
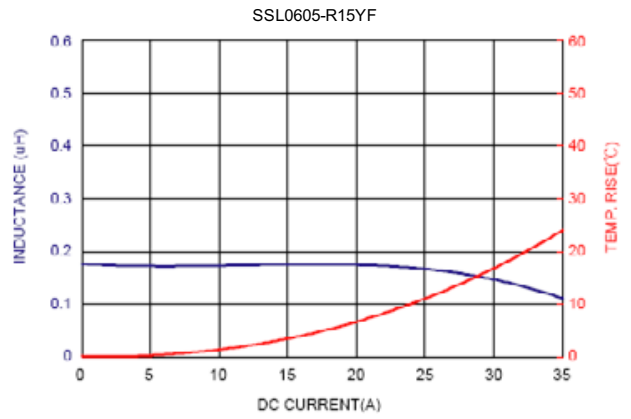
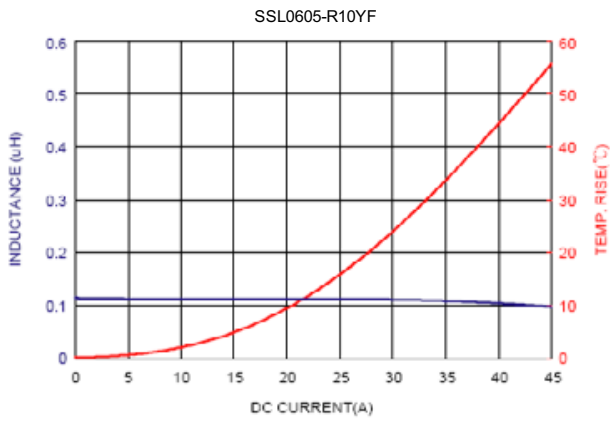
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6. CHARACTERISTICS CURVES :



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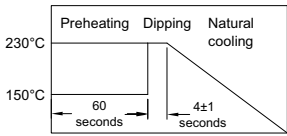
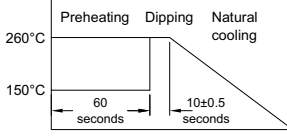
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7. RELIABILITY AND TEST CONDITION :

ITEM	PERFORMANCE	TEST CONDITION														
Electrical Characteristics Test																
Inductance	Refer to standard electrical characteristics list	HP4284A, CH11025, CH3302, CH1320, CH1320S LCR meter.														
DCR		CH16502, Agilent33420A Micro-Ohm Meter.														
Heat Rated Current (Irms)		Irms(A) will cause the coil temperature rise approximately $\Delta T=40^{\circ}\text{C}$ without core loss 1. Applied the allowed DC current 2. Temperature measured by digital surface thermometer														
Saturation Current (Isat)		Isat(A) will cause Lo to drop approximately 20%														
Mechanical Performance Test																
Solderability Test	More than 90% of the terminal electrode should be covered with solder. 	Preheat : 150°C, 60sec. Solder : Sn-Ag3.0-Cu0.5 Solder Temperature : 230±5°C Flux for lead free : rosin Dip Time : 4±1sec.														
Solder Heat Resistance	1. Appearance : No significant abnormality 2. Inductance change : Within ±20% 	Preheat : 150°C, 60sec. Solder : Sn-Ag3.0-Cu0.5 Solder Temperature : 260±5°C Flux for lead free : rosin Dip Time : 10±0.5sec.														
Reliability Test																
High Temperature Life Test	1. Appearance : No damage 2. Inductance : Within ±20% of initial value. No disconnection or short circuit.	Temperature : 125±5°C Time : 500±12 hours Measure at room temperature after placing for 2 to 3 hrs.														
Low Temperature Life Test		Temperature : -55±5°C Time : 500±12 hours Measure at room temperature after placing for 2 to 3 hrs.														
Thermal Shock		Conditions of 1 cycle. <table border="1" data-bbox="922 1361 1289 1496"> <thead> <tr> <th>Step</th> <th>Temperature (°C)</th> <th>Times (min.)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>-55±3</td> <td>30±3</td> </tr> <tr> <td>2</td> <td>Room Temperature</td> <td>Within 3</td> </tr> <tr> <td>3</td> <td>+125±3</td> <td>30±3</td> </tr> <tr> <td>4</td> <td>Room Temperature</td> <td>Within 3</td> </tr> </tbody> </table> Total : 5 cycles Measure at room temperature after placing for 2 to 3 hrs.	Step	Temperature (°C)	Times (min.)	1	-55±3	30±3	2	Room Temperature	Within 3	3	+125±3	30±3	4	Room Temperature
Step	Temperature (°C)	Times (min.)														
1	-55±3	30±3														
2	Room Temperature	Within 3														
3	+125±3	30±3														
4	Room Temperature	Within 3														
Humidity Resistance	1. Appearance : No damage 2. Inductance : Within ±20% of initial value. No disconnection or short circuit.	Temperature : 40±5°C Humidity : 90% to 95% Applied Current : Rated Current Time : 500±12 hours Measure at room temperature after placing for 2 to 3 hrs.														



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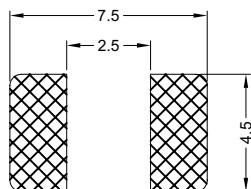
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8. SOLDERIND AND MOUNTING :

8-1. Recommended PC Board Pattern (Unit : mm)



8-2. Soldering

Mildly activated rosin fluxes are preferred. The minimum amount of solder can lead to damage from the stresses caused by the difference in coefficients of expansion between solder, chip and substrate. Our terminations are suitable for all wave and re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

8-2.1 Solder Re-flow :

Recommended temperature profiles for re-flow soldering in Figure 1.

8-2.2 Soldering Iron (Figure 2) :

Products attachment with soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.

Note :

- Preheat circuit and products to 150°C.
- 280°C tip temperature (max)
- Never contact the ceramic with the iron tip
- 1.0mm tip diameter (max)
- Use a 20 watt soldering iron with tip diameter of 1.0mm
- Limit soldering time to 3 secs.

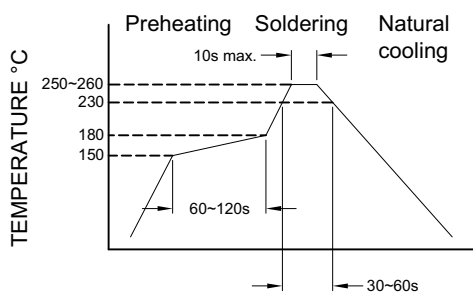


Figure 1. Re-flow Soldering

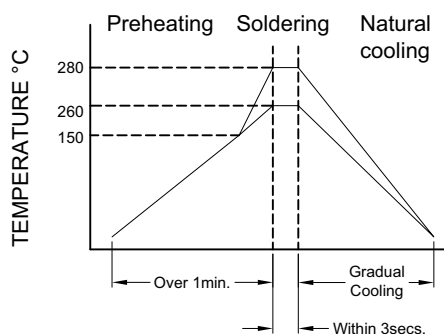


Figure 2. Iron Soldering



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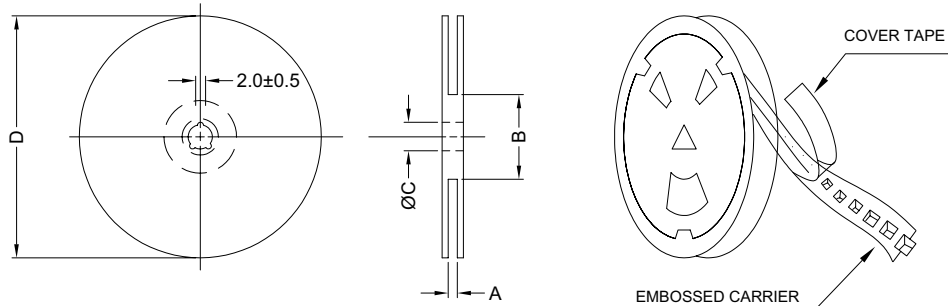


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PG. 4

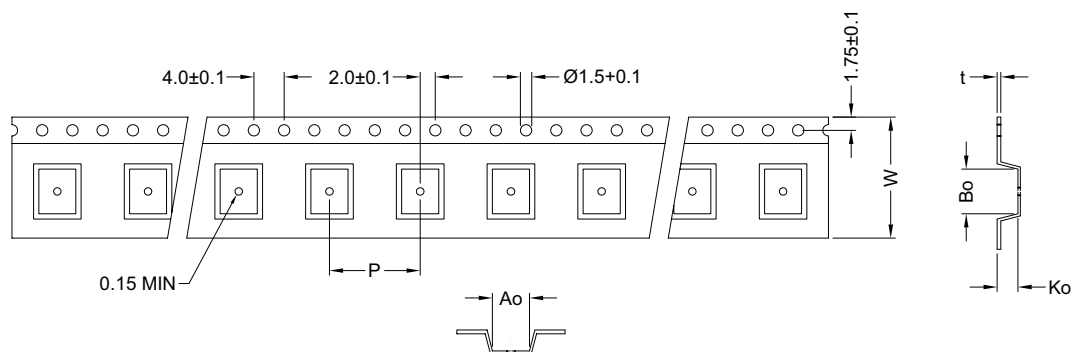
9. PACKAGING INFORMATION :

9-1. Reel Dimension



Type	A(mm)	B(mm)	C(mm)	D(mm)
13" x 16mm	16.0±0.5	75±2	13.5±0.5	330

9-2 Tape Dimension



Series	Ao(mm)	Bo(mm)	Ko(mm)	P(mm)	W(mm)	t(mm)
SSL0605	7.2±0.1	7.2±0.1	5.4±0.1	12.0±0.1	16.0±0.3	0.35±0.05

9-3 Packaging Quantity

Size	SSL0605
Chip / Reel	900
Inner Box	3600
Carton	7200



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